





VCR4N N-Channel Voltage Controlled Resistor JFET

Features

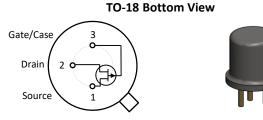
- InterFET N0016H Geometry
- Low Leakage: 10pA Typical
- Low Input Capacitance: 1.0 pF Typical
- RoHS Compliant
- SMT, TH, and Bare Die Package options.

Applications

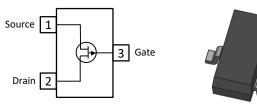
- Small Signal Attenuators
- Filters
- Amplifier Gain Control
- Oscillator Amplitude Control

Description

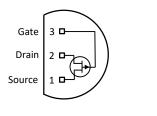
The -15V InterFET VCR4N Voltage Controlled Resistor JFET are targeted for high input impedance applications. Gate leakages are less than 10pA at room temperatures. The resistance range of the VCR4N is 200 Ohms to 600 Ohms. The TO-18 package is hermetically sealed and suitable for military applications.







TO-92 Bottom View





Product Summary

	Parameters	VCR4N Min	Unit
BV _{GSS}	Gate to Source Breakdown Voltage	-15	V
V _{GS(off)}	Gate to Source Cutoff Voltage	-3.5	V
r _{ds(on)}	Drain to Source ON Resistance	200	Ω

Ordering Information Custom Part and Binning Options Available

Part Number	Description	Case	Packaging
VCR4N	Through-Hole	TO-72	Bulk
PNVCR4N	Through-Hole	TO-92	Bulk
SMPVCR4N	Surface Mount	SOT23	Bulk
	7" Tape and Reel: Max 3,000 Pieces		Minimum 1,000 Pieces
SMPVCR4NTR	13" Tape and Reel: Max 9,000 Pieces	SOT23	Tape and Reel
VCR4NCOT	Chip Orientated Tray (COT Waffle Pack)	СОТ	400/Waffle Pack
VCR4NCFT	Chip Face-up Tray (CFT Waffle Pack)	CFT	400/Waffle Pack



Disclaimer: It is the Buyers responsibility for designing, validating and testing the end application under all field use cases and extreme use conditions. Guaranteeing the application meets required standards, regulatory compliance, and all safety and security requirements is the responsibility of the Buyer. These resources are subject to change without notice.







Electrical Characteristics

Maximum Ratings (@ T_A = 25°C, Unless otherwise specified)

	Parameters	Value	Unit
VRGS	Reverse Gate Source and Gate Drain Voltage	-15	V
I_{FG}	Continuous Forward Gate Current	10	mA
PD	Continuous Device Power Dissipation	300	mW
Р	Power Derating	2.4	mW/°C
Τı	Operating Junction Temperature	-55 to 125	°C
T _{STG}	Storage Temperature	-65 to 150	°C

Static Characteristics (@ TA = 25°C, Unless otherwise specified)

			VCR4N		
	Parameters	Conditions	Min	Max	Unit
V(BR)GSS	Gate to Source	$I_G = -1\mu A, V_{DS} = 0V$	-15		V
	Breakdown Voltage				v
I _{GSS}	Gate to Source	V_{GS} = -15V, V_{DS} = 0V		-0.2	nA
	Reverse Current			-0.2	IIA
Vgs(off)	Gate to Source	$V_{DS} = 10V, I_D = -1\mu A$	-3.5	-7	V
	Cutoff Voltage		-3.5	-7	

Dynamic Characteristics (@ TA = 25°C, Unless otherwise specified)

			VCR4N		
	Parameters	Conditions	Min	Max	Unit
r _{ds(on)}	Drain to Source ON Resistance	$I_D = OA, V_{GS} = OV,$ f = 1kHz	200	600	Ω
C _{dg}	Drain Gate Capacitance	$V_{DG} = 10V, I_S = 0A,$ f = 1MHz		3	pF
C _{sg}	Source Gate Capacitance	$V_{GS} = 10V, I_D = 0A,$ f = 1MHz		3	pF



Technical

Support

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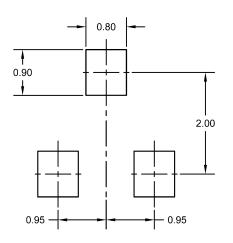
SOT23 (TO-236AB) Mechanical and Layout Data

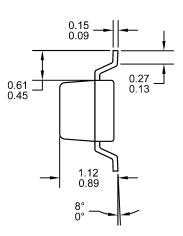
Package Outline Data





Suggested Pad Layout





- 1. All linear dimensions are in millimeters.
- 2. Package weight approximately 0.12 grams
- 3. Molded plastic case UL 94V-0 rated
- For Tape and Reel specifications refer to InterFET CTC-021 Tape and Reel Specification, Document number: IF39002
- 5. Bulk product is shipped in standard ESD shipping material
- 6. Refer to JEDEC standards for additional information.

- 1. All linear dimensions are in millimeters.
- 2. The suggested land pattern dimensions have been provided for reference only. A more robust pattern may be desired for wave soldering.

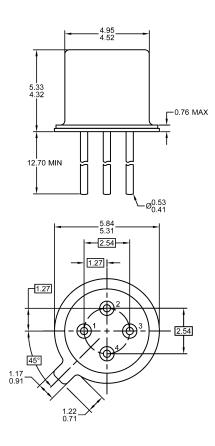




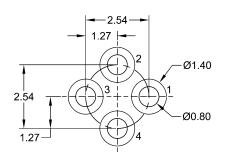
VCR4N

TO-72 Mechanical and Layout Data

Package Outline Data



Suggested Through-Hole Layout



- 1. All linear dimensions are in millimeters.
- 2. Four leaded device. Not all leads are shown in drawing views.
- 3. Package weight approximately 0.31 grams
- 4. Bulk product is shipped in standard ESD shipping material
- 5. Refer to JEDEC standards for additional information.

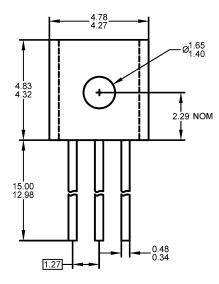
- 1. All linear dimensions are in millimeters.
- 2. The suggested land pattern dimensions have been provided as a straight lead reference only. A more robust pattern may be desired for wave soldering and/or bent lead configurations.

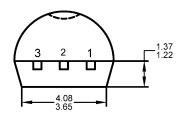




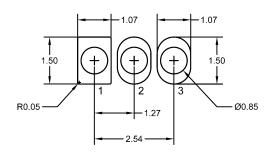
TO-92 Mechanical and Layout Data

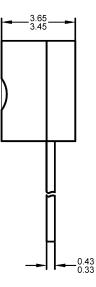
Package Outline Data





Suggested Through-Hole Layout





- 1. All linear dimensions are in millimeters.
- 2. Package weight approximately 0.19 grams
- 3. Molded plastic case UL 94V-0 rated
- 4. Bulk product is shipped in standard ESD shipping material
- 5. Refer to JEDEC standards for additional information.

- 1. All linear dimensions are in millimeters.
- The suggested land pattern dimensions have been provided as a straight lead reference only. A more robust pattern may be desired for wave soldering and/or bent lead configurations.

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